











Board Stack Up
 Layers: Thickness(mils):
 Top 1.35 (1 oz copper)
 Dielectric 4.5
 GND1 1.35 (1 oz copper)
 Dielectric 47.6
 GND2 1.35 (1 oz copper)
 Dielectric 4.5
 Bottom 1.35 (1 oz copper)

board material = FR4
 overall board dimensions = 150.74 mm * 19.80mm
 solder mask color = green
 silkscreen color = white
 Total Board thickness = 62mils